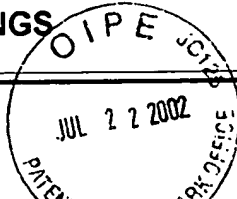


## TRANSMITTAL OF FORMAL DRAWINGS

Docket No.  
POU920000148US1

In Re Application Of: R. C. Chu et al



Serial No.

Filing Date

Confirmation No.

Examiner

Art Unit

10/040,680

November 9, 2001

2926

N/A

3744

Invention: Enhanced Air Cooling of Electronic Devices Using Fluid Phase Heat Transfer

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Transmitted herewith are:

13 sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).RECEIVED  
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Signature

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Dated: July 17, 2002

I certify that this document and attached formal drawings  
are being deposited on July 17, 2002 with the U.S.  
Postal Service as first class mail under 37 C.F.R. 1.8 and  
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Signature of Person Mailing Correspondence

Sandra L. Kilmer

Typed or Printed Name of Person Mailing Correspondence